

AOZ8351ADI-04

1-Channel Unidirectional High Surge TVS

General Description

The AOZ8351ADI-04 is a 1-channel unidirectional high surge transient voltage suppressor designed to protect power rails such as battery and Vbus from damaging ESD or surge events.

This device consists of a unidirectional TVS diode in a single package. During transient events, the diode directs the transient to either the positive side of the power supply line or to ground.

The AOZ8351ADI-04 provides a typical line-to-ground capacitance of 2100 pF and low clamping voltage making it ideally suited for power rail protection in mobile and computing devices.

The AOZ8351ADI-04 comes in a RoHS compliant and Halogen Free 2.0 mm x 1.25 mm x 0.5 mm package and is rated for -40°C to +125°C junction temperature range.

Features

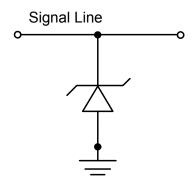
- ESD protection for high-speed data lines:
 - IEC 61000-4-2 (ESD immunity):
 - Air discharge: ±30 kV
 - Contact discharge: ±30 kV
 - IEC61000-4-5 (Lightning, 8/20 μs): 220 A
- Capacitance between I/O to GND: 2100 pF
- Low clamping voltage
- Reverse Working Voltage: 4.8 V

Applications

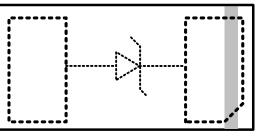
- Battery
- Mobile devices
- Notebook computers



Typical Application



Pin Configuration



DFN2.0x1.25A 2L



Ordering Information

Part N	lumber	Ambient Temperature Range	Package	Environmental
AOZ83	51ADI-04	-40°C to +125°C	DFN2.0x1.25A-2L	Green Product



AOS Green Products use reduced levels of Halogens, and are also RoHS compliant.

Please visit www.aosmd.com/media/AOSGreenPolicy.pdf for additional information.

Absolute Maximum Ratings

Exceeding the Absolute Maximum ratings may damage the device.

Parameter	Rating
Storage Temperature (T _S)	-65°C to +150°C
ESD Rating per IEC61000-4-2, contact ⁽¹⁾	±30kV
ESD Rating per IEC61000-4-2, air ⁽¹⁾	±30kV
8/20µs Surge IEC61000-4-5	±220A

Notes:

- 1. IEC 61000-4-2 discharge with C $_{\rm Discharge}$ = 150pF, R $_{\rm Discharge}$ = 330 $\Omega.$
- 2. Human Body Discharge per MIL-STD-883, Method 3015 $C_{Discharge}$ = 100pF, $R_{Discharge}$ = 1.5k Ω .

Maximum Operating Ratings

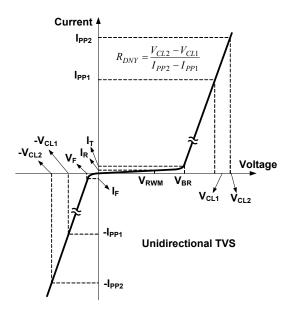
Parameter	Rating
Junction Temperature (T _J)	-40°C to +125°C

Rev. 1.0 December 2018 **www.aosmd.com** Page 2 of 7



Electrical Characteristics

 $T_A = 25$ °C unless otherwise specified.



Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
V_{RWM}	Reverse Working Voltage				4.8	V
V_{BR}	Reverse Breakdown Voltage	I _T = 1mA	6	7	8.5	V
I _R	Reverse Leakage Current	V _T =Max. V _{RWM}		0.1	0.5	μΑ
V _F	Forward Voltage	I _F = 15mA		0.85		V
		I _{PP} = 1A		7.5	8.5	V
V	Clamping Voltage ⁽³⁾ IEC61000-4-5 Surge 8/20µs	I _{PP} = 100A		10	11.5	V
V_{CL}		I _{PP} = 150A		11	12.5	V
		I _{PP} = 220A		12.8	14	V
R _{DNY}	Dynamic Resistance ⁽³⁾	I _{PP} = 1A to 220A		0.025		Ω
CJ	Junction Capacitance	V _{I/O} = 0V, f = 1MHz,		2100		pF

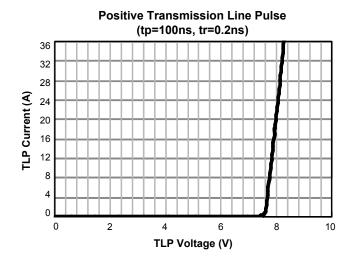
Note:

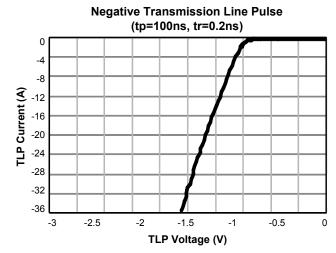
3. These specifications are guaranteed by design and characterization.

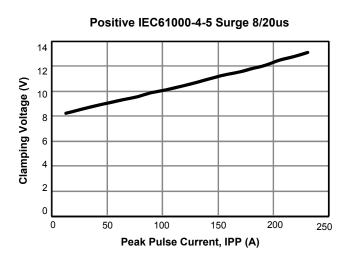
Rev. 1.0 December 2018 www.aosmd.com Page 3 of 7

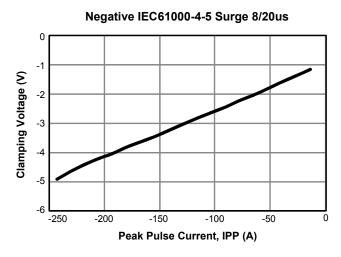


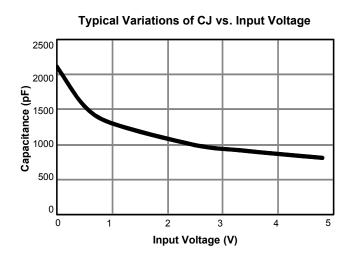
Typical Characteristics





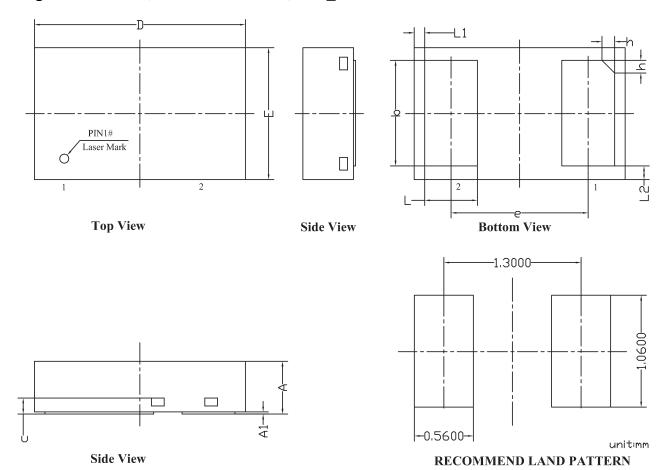








Package Dimensions, DFN2.0x1.25A-2L, EP2_S



SYMBOLS	DIMENSIO	NS IN MILL	IMETERS	DIME	NSIONS IN IN	ICHES	
3 I MBOL3	MIN	NOM	MAX	MIN	NOM	MAX	
A	0.450	0.500	0.550	0.0177	0.0197	0.0217	
A1	0.000	0.020	0.050	0.0000	0.0008	0.0020	
b	0.950	1.000	1.050	0.0374	0.0394	0.0413	
С	0	.152REF	,	0.0060REF			
D	1.900	2.000	2.100	0.0748	0.0787	0.0827	
e	1	.300BSC	()	0.0512BSC			
Е	1.200	1.250	1.300	0.0472	0.0492	0.0512	
L	0.450	0.500	0.550	0.0177	0.0197	0.0217	
L1	0).100REF		0.0039REF			
L2	().130REF		0.0051REF			
h	().120REI	7	0.0047REF			

NOTE

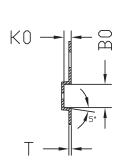
- 1. ALL DIMENSIONS ARE IN MILL IMETERS.
- 2. DIMENSIONS ARE INCLUSIVE OF PLATING.
- 3. PACKAGE BODY SIZES EXCLUDE MOLD FLASH AND GATE BURRS. MOLD FLASH AT THE NON-LEAD SIDES SHOULD BE LESS THAN 6MIL EACH.
- 4. CONTROLLING DIMENSION IS MILLIMETER. CONVERTED INCH DIMENSIONS ARE NOT NECESSARILY EXACT.
- 5. PADDLE EXPOSED ON BOTTOM.

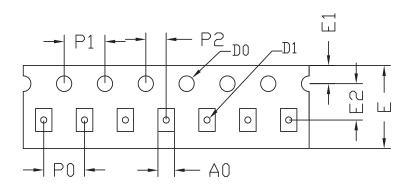
Rev. 1.0 December 2018 **www.aosmd.com** Page 5 of 7



Tape and Reel Dimensions, DFN2.0x1.25A-2L, EP2_S



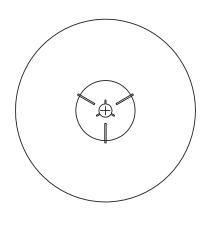


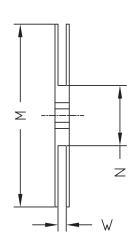


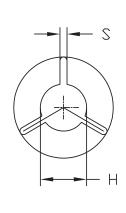
UNIT: MM

PACKAGE	Α0	В0	K0	DO	D1	E	E1	E2	P0	P1	P2	Т
DFN2.0×1.25	1.61 ±0.05	2.21 ±0.05	0.70 ±0.05	Ø1.50 +0.10 -0.00	Ø0.60 ±0.05	8.00 +0.3 -0.1	1.75 ±0.1	3.50 ±0.05	4.00 ±0.1	4.0 ±0.10	2.0 ±0.05	0.23 ±0.02

REEL







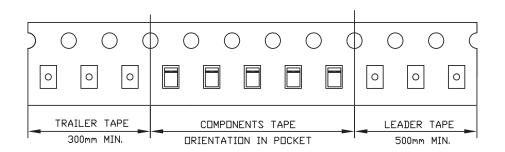
UNIT: MM

TAPE SIZE	REEL SIZE	М	N	W	Н	S
8	Ø180	Ø180.0 ±1.0	ø54.4 ±1.0	8.60 +1.00 -0.00	Ø13.0 +0.5 -0.2	2.00 +0.5 -0.0

TAPE

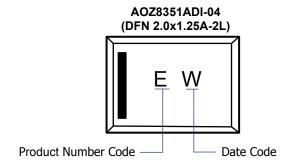
Leader / Trailer & Orientation

Unit Per Reel: 3000pcs





Part Marking



LEGAL DISCLAIMER

Applications or uses as critical components in life support devices or systems are not authorized. AOS does not assume any liability arising out of such applications or uses of its products. AOS reserves the right to make changes to product specifications without notice. It is the responsibility of the customer to evaluate suitability of the product for their intended application. Customer shall comply with applicable legal requirements, including all applicable export control rules, regulations and limitations.

AOS' products are provided subject to AOS' terms and conditions of sale which are set forth at: http://www.aosmd.com/terms and conditions of sale

LIFE SUPPORT POLICY

ALPHA AND OMEGA SEMICONDUCTOR PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS.

As used herein:

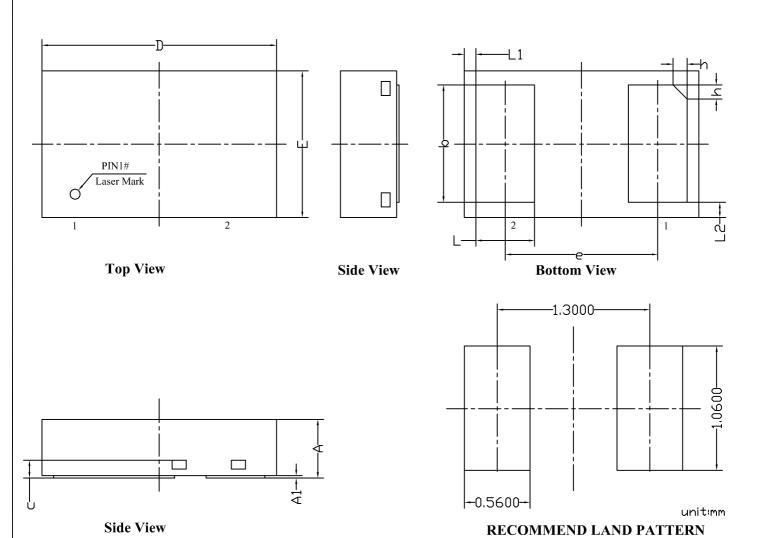
- 1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- 2. A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

Rev. 1.0 December 2018 **www.aosmd.com** Page 7 of 7



Document No.	PO-00305
Version	A

DFN2.0x1.25A_2L_EP2_S PACKAGE OUTLINE



SYMBOLS	DIMENSIO	NS IN MILL	IMETERS	DIME	NSIONS IN IN	ICHES	
S I MBOLS	MIN	NOM	MAX	MIN	NOM	MAX	
Α	0.450	0.500	0.550	0.0177	0.0197	0.0217	
A1	0.000	0.020	0.050	0.0000	0.0008	0.0020	
b	0.950	1.000	1.050	0.0374	0.0394	0.0413	
С	0	.152REF	7	0.0060REF			
D	1.900	2.000	2.100	0.0748	0.0787	0.0827	
e	1	.300BSC		0.0512BSC			
Е	1.200	1.250	1.300	0.0472	0.0492	0.0512	
L	0.450	0.500	0.550	0.0177	0.0197	0.0217	
L1	().100REF	7	0.0039REF			
L2	0.130REF			0.0051REF			
h	().120REF	7	0.0047REF			

NOTE

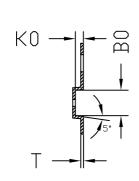
- 1. ALL DIMENSIONS ARE IN MILL IMETERS.
- 2. DIMENSIONS ARE INCLUSIVE OF PLATING.
- 3. PACKAGE BODY SIZES EXCLUDE MOLD FLASH AND GATE BURRS. MOLD FLASH AT THE NON-LEAD SIDES SHOULD BE LESS THAN 6MIL EACH.
- 4. CONTROLLING DIMENSION IS MILLIMETER. CONVERTED INCH DIMENSIONS ARE NOT NECESSARILY EXACT.
- 5. PADDLE EXPOSED ON BOTTOM.

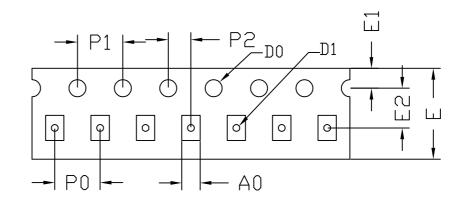


DFN2.0x1.25_2L_EP2_S Tape and Reel Data

DFN2.0x1.25 2L EP2 S

Carrier Tape



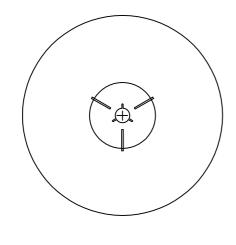


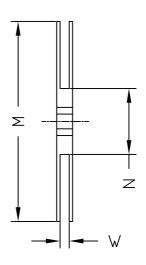
UNIT: MM

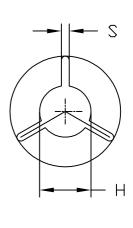
PACKAGE	Α0	В0	K0	DO	D1	E	E1	E2	P0	P1	P2	Т
DFN2.0×1.25	1.61 ±0.05	2.21 ±0.05	0.70 ±0.05	Ø1.50 +0.10 -0.00	Ø0.60 ±0.05	8.00 +0.3 -0.1	1.75 ±0.1	3.50 ±0.05	4.00 ±0.1	4.0 ±0.10	2.0 ±0.05	0.23 ±0.02

DFN2.0x1.25 2L EP2 S

REEL







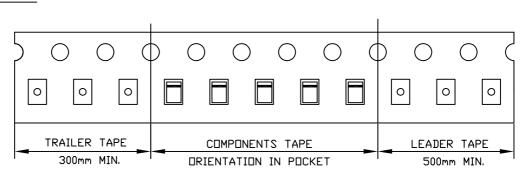
UNIT: MM

TAPE SIZE	REEL SIZE	М	N	W	Н	S
8	Ø180	Ø180.0 ±1.0	Ø54.4 ±1.0	8.60 +1.00 -0.00	Ø13.0 +0.5 -0.2	2.00 +0.5 -0.0

DFN2.0x1.25 2L EP2 S TAPE

Leader / Trailer & Orientation

Unit Per Reel: 3000pcs





AOS Semiconductor Product Reliability Report

AOZ8351ADI-04, rev A

Plastic Encapsulated Device

ALPHA & OMEGA Semiconductor, Inc www.aosmd.com



This AOS product reliability report summarizes the qualification result for AOZ8351ADI-04. Accelerated environmental tests are performed on a specific sample size, and then followed by electrical test at end point. Review of final electrical test result confirms that AOZ8351ADI-04 passes AOS quality and reliability requirements. The released product will be categorized by the process family and be routine monitored for continuously improving the product quality.

I. Reliability Stress Test Summary and Results

Test Item	Test Condition	Time Point	Total Sample Size	Number of Failures	Reference Standard
HTRB	Temp = 150°C , Vdd=100% of VRWMmax	168 / 500 / 1000 hours	231 pcs	0	JESD22-A108
Precondition (Note A)	168hr 85°C / 85%RH + 3 cycle reflow@260°C	-	693 pcs	0	JESD22-A113
HAST	130°C , 85%RH, 33.3 psia, Vdd = 80% of VRWMmax	96 hours	231 pcs	0	JESD22-A110
Autoclave	121°C , 29.7psia, RH=100%	96 hours	231 pcs	0	JESD22-A102
Temperature Cycle	-65°C to 150°C , air to air	250 / 500 cycles	231 pcs	0	JESD22-A104

Note: The reliability data presents total of available generic data up to the published date. Note A: MSL (Moisture Sensitivity Level) 1 based on J-STD-020

II. Reliability Evaluation

FIT rate (per billion): 15.26

MTTF = 7480 years

The presentation of FIT rate for the individual product reliability is restricted by the actual burn-in sample size. Failure Rate Determination is based on JEDEC Standard JESD 85. FIT means one failure per billion hours.

Failure Rate =
$$\text{Chi}^2 \times 10^9 / [2 \text{ (N) (H) (Af)}] = 15.26$$

MTTF = $10^9 / \text{FIT} = 7480 \text{ years}$

Chi² = Chi Squared Distribution, determined by the number of failures and confidence interval

N = Total Number of units from burn-in tests

H = Duration of burn-in testing

Af = Acceleration Factor from Test to Use Conditions (Ea = 0.7eV and Tuse = 55°C)

Acceleration Factor [Af] = Exp [Ea / k (1/Tj u - 1/Tj s)]

Acceleration Factor ratio list:

	55 deg C	70 deg C	85 deg C	100 deg C	115 deg C	130 deg C	150 deg C
Af	259	87	32	13	5.64	2.59	1

Tj s = Stressed junction temperature in degree (Kelvin), K = C+273.16

Tj u =The use junction temperature in degree (Kelvin), K = C+273.16

k = Boltzmann's constant, 8.617164 X 10⁻⁵eV / K